



**Communication of Material Information**

**Scotiabank Chile**

Santiago, May 30, 2023

**Financial Market Commission**

In compliance with the provisions of articles 9 and 10 of Law No. 18,045 on the Securities Market, and letter A.a) of the Section II of the General Rule No. 486, and number 5.1.7 of the Section IV of the General Rule No. 30 of the Commission for the Financial Market (hereinafter, the "CMF"), hereby report as a Material Fact the following: On May 30, 2023, Scotiabank Chile (hereinafter, the "Bank") carried-out a placement of one dematerialized and bearer bonds.

The specific conditions of the placement were as follow:

- Series BH bonds, for a total amount of 750,000 Unidades de Fomento (equivalent to approximately USD 33.5 million), maturing on March 9, 2029. The average placement rate of the securities was 3.50%. These bonds were charged to the line registered in the Securities Registry of the CMF under number 7/2021 dated March 1, 2022.

Rafael Bilbao

General Counsel Scotiabank Chile

(Free translation of Spanish Communication)